

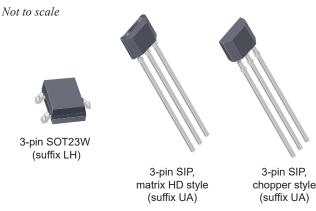
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## FEATURES AND BENEFITS

- Symmetrical switchpoints
- Superior temperature stability
- Operation from unregulated supply
- Open-drain 25 mA output
- Reverse battery protection
- Activate with small, commercially available permanent magnets
- Solid-state reliability
- Small size
- Resistant to physical stress
- Enhanced ESD structures result in 8 kV HBM ESD performance without external protection components
- Internal protection circuits enable 40 V load dump compliance without external protection components

## PACKAGES:



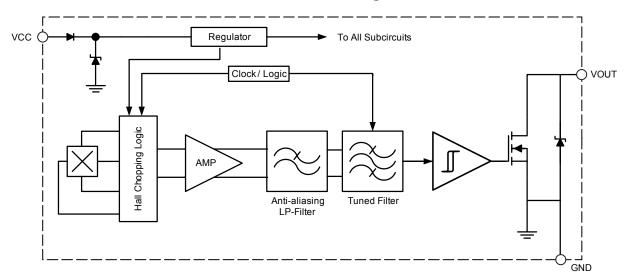
## DESCRIPTION

These Hall-effect latches are extremely temperature-stable and stress resistant sensor ICs especially suited for operation over extended temperature ranges to 150°C. Superior hightemperature performance is made possible through a novel Schmitt trigger circuit that maintains operate and release point symmetry by compensating for temperature changes in the Hall element. Additionally, internal compensation provides magnetic switchpoints that become more sensitive with temperature, hence offsetting the usual degradation of the magnetic field with temperature. The symmetry capability makes these devices ideal for use in pulse-counting applications where duty cycle is an important parameter. The three basic devices (A1225, A1227, and A1229) are identical except for magnetic switchpoints.

Each device includes on a single silicon chip a voltage regulator, Hall-voltage generator, temperature compensation circuit, signal amplifier, Schmitt trigger, and a buffered open-drain output to sink up to 25 mA. The on-board regulator permits operation with supply voltages of 3.8 to 24 V.

The first character of the part number suffix determines the device operating temperature range. Suffix L is for  $-40^{\circ}$ C to 150°C. Two package styles provide magnetically optimized packages for most applications. Suffix LH is a 3-pin SOT23W surface-mount package; suffix UA is a 3-pin ultramini SIP for through-hole mounting. The packages are lead (Pb) free with 100% matte-tin leadframe plating.

## **Functional Block Diagram**



### SELECTION GUIDE

| Part Number  | Packing <sup>[1]</sup>                                   | Package                     | Ambient<br>Temperature, T <sub>A</sub> | B <sub>RP</sub> (min)<br>(G) | B <sub>OP</sub> (max)<br>(G) |
|--------------|--|-----------------------------|--|------------------------------|------------------------------|
| A1225LLHLT-T | 7-in. reel, 3000 pieces/reel                             | 3-pin SOT-23W surface mount |  |                              |                              |
| A1225LLHLX-T | 13-in. reel, 10000 pieces/reel                           | 3-pin SOT-23W surface mount | –40°C to 150°C                         | -300                         | 300                          |
| A1225LUA-T   | Bulk, 500 pieces/bag                                     | 3-pin SIP through hole      |  |                              | 1                            |
| A1227LLHLT-T | 7-in. reel, 3000 pieces/reel                             | 3-pin SOT-23W surface mount |  |                              |                              |
| A1227LLHLX-T | 13-in. reel, 10000 pieces/reel                           | 3-pin SOT-23W surface mount | –40°C to 150°C                         | -175                         | 175                          |
| A1227LUA-T   | Bulk, 500 pieces/bag                                     | 3-pin SIP through hole      |  |                              |                              |
| A1229LLHLT-T | 7-in. reel, 3000 pieces/reel 3-pin SOT-23W surface mount |                             |  |                              |                              |
| A1229LLHLX-T | 13-in. reel, 10000 pieces/reel                           | 3-pin SOT-23W surface mount | –40°C to 150°C                         | -200                         | 200                          |
| A1229LUA-T   | Bulk, 500 pieces/bag                                     | 3-pin SIP through hole      |  |                              |                              |

<sup>[1]</sup> Contact Allegro<sup>™</sup> for additional packaging options.



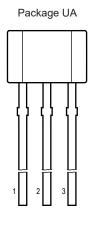
### **ABSOLUTE MAXIMUM RATINGS**

| Characteristic Symbol         |                        | Notes   | Rating     | Unit |  |
|-------------------------------|------------------------|---------|------------|------|--|
| Forward Supply Voltage        | V <sub>cc</sub>        |         | 30         | V    |  |
| Reverse Supply Voltage        | V <sub>RCC</sub>       |         | -30        | V    |  |
| Output Off Voltage            | V <sub>OUT</sub>       |         | 30         | V    |  |
| Reverse Output Voltage        | V <sub>ROUT</sub>      |         | -0.5       | V    |  |
| Continuous Output Current     | I <sub>OUT(SINK)</sub> |         | 25         | mA   |  |
| Operating Ambient Temperature | T <sub>A</sub>         | Range L | -40 to 150 | °C   |  |
| Maximum Junction Temperature  | T <sub>J</sub> (max)   |         | 165        | °C   |  |
| Storage Temperature           | T <sub>stg</sub>       |         | -65 to 170 | °C   |  |

### **Pinout Diagrams**

Package LH





### **Terminal List Table**

| Number |    | Name | Function           |  |
|--------|----|------|--------------------|--|
| LH     | UA | Name | Function           |  |
| 1      | 1  | VCC  | Input power supply |  |
| 2      | 3  | VOUT | Output signal      |  |
| 3      | 2  | GND  | Ground             |  |



## **ELECTRICAL CHARACTERISTICS:** Valid at $T_A = -40$ °C to 150°C, $C_{BYPASS} = 0.1 \mu$ F, $V_{CC} = 12$ V, unless otherwise noted

| Characteristics                                 | Symbol                | Test Conditions                                    |                                  | Min. | Typ. [1] | Max. | Unit <sup>[2]</sup> |
|---|-----------------------|--|----------------------------------|------|----------|------|---------------------|
| ELECTRICAL CHARACTERISTI                        | cs                    |  |                                  |      |          |      |                     |
| Supply Voltage                                  | V <sub>CC</sub>       | Operating; T <sub>J</sub> ≤ 165°C                  |                                  | 3.8  |          | 24   | V                   |
|   |                       | B < B <sub>RP</sub> (Output off)                   |                                  |      | _        | 6    | mA                  |
| Supply Current                                  | I <sub>CC</sub>       | B > B <sub>OF</sub>                                | B > B <sub>OP</sub> (Output on)  |      | _        | 6    | mA                  |
| Supply Zener Voltage                            | V <sub>Z(sup)</sub>   | I <sub>CC</sub> = 9                                | mA, T <sub>A</sub> = 25°C        | 28   | _        | _    | V                   |
| Reverse Battery Current                         | I <sub>Z(sup)</sub>   | V <sub>RCC</sub> =                                 | –28 V, T <sub>A</sub> = 25°C     |      | -        | - 5  | mA                  |
| Power-On Time <sup>[3]</sup>                    | t <sub>PO</sub>       |  |                                  |      | _        | 12   | μs                  |
| Power-On State                                  | POS                   | B < B <sub>OP</sub>                                |                                  | _    | HIGH     | _    | _                   |
| Chopping Frequency                              | f <sub>chop</sub>     |  |                                  | _    | 400      | _    | kHz                 |
| OUTPUT STAGE CHARACTERIS                        | STICS                 |  |                                  |      |          |      |                     |
| Output Saturation Voltage                       | V <sub>OUT(sat)</sub> | I <sub>OUT</sub> = 2                               | 20 mA                            | _    | 175      | 400  | mV                  |
| Output Leakage Current                          | I <sub>OFF</sub>      | V <sub>OUT</sub> =                                 | 24 V, B < B <sub>RP</sub>        | _    | < 1      | 10   | μA                  |
| Output Rise Time <sup>[3][4]</sup>              | t <sub>r</sub>        | R <sub>L</sub> = 820 Ω, C <sub>L</sub> = 20 pF     |                                  | _    | 200      | 2000 | ns                  |
| Output Fall Time <sup>[3][4]</sup>              | t <sub>f</sub>        | R <sub>L</sub> = 820 Ω, C <sub>L</sub> = 20 pF     |                                  | _    | 200      | 2000 | ns                  |
| Output Zener Voltage                            | V <sub>Z(out)</sub>   | $I_{OUT} = 3 \text{ mA}, T_A = 25^{\circ}\text{C}$ |                                  | 30   | _        | _    | V                   |
| MAGNETIC CHARACTERISTICS                        |                       | ·  |                                  |      | ·        |      |                     |
|   |                       | A1225  | T <sub>A</sub> = 25°C            | 170  | _        | 270  | G                   |
|   |                       |  | Over operating temperature range | 140  | _        | 300  | G                   |
|   |                       | A1227  | $T_A = 25^{\circ}C$              | 50   | _        | 150  | G                   |
| Operate Point                                   | B <sub>OP</sub>       |  | Over operating temperature range | 50   | _        | 175  | G                   |
|   |                       | A1229  | T <sub>A</sub> = 25°C            | 100  | _        | 180  | G                   |
|   |                       |  | Over operating temperature range | 80   | -        | 200  | G                   |
|   |                       | A1225  | T <sub>A</sub> = 25°C            | -270 | _        | -170 | G                   |
|   |                       |  | Over operating temperature range | -300 | -        | -140 | G                   |
| Release Point                                   |                       | A1227  | T <sub>A</sub> = 25°C            | -150 | _        | -50  | G                   |
|   | B <sub>RP</sub>       |  | Over operating temperature range | -175 | _        | -50  | G                   |
|   |                       | A1229  | $T_A = 25^{\circ}C$              | -180 | _        | -100 | G                   |
|   |                       |  | Over operating temperature range | -200 | _        | -80  | G                   |
|   |                       | A1225  | T <sub>A</sub> = 25°C            | 340  | -        | 540  | G                   |
|   |                       |  | Over operating temperature range | 280  | -        | 600  | G                   |
|   |                       | A1227  | T <sub>A</sub> = 25°C            | 100  |          | 300  | G                   |
| Hysteresis (B <sub>OP</sub> – B <sub>RP</sub> ) | B <sub>HYS</sub>      |  | Over operating temperature range | 100  | _        | 350  | G                   |
|   |                       |  | T <sub>A</sub> = 25°C            | 200  | _        | 360  | G                   |
|   |                       | A1229  | Over operating temperature range | 160  | _        | 400  | G                   |

<sup>[1]</sup> Typical data are at  $T_A = 25^{\circ}$ C and  $V_{CC} = 12$  V, and are for design estimations only. <sup>[2]</sup> 1 G (gauss) = 0.1 mT (millitesla).

<sup>[3]</sup> Minimum and maximum specifications verified by bench characterization and not guaranteed by Allegro final test.

 $^{[4]}C_{L}$  = oscilloscope probe capacitance.

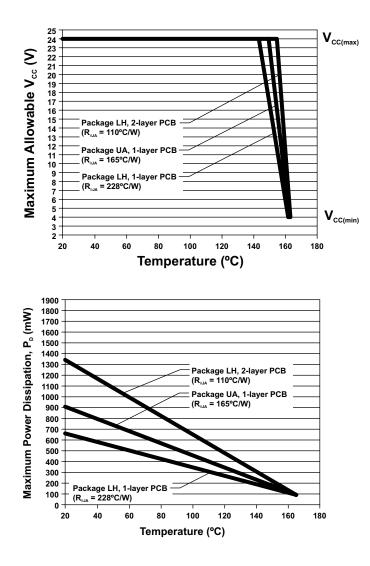


# A1225, A1227 and A1229

# Hall-Effect Latch for High Temperature Operation

### THERMAL CHARACTERISTICS: May require derating at maximum conditions; see application information

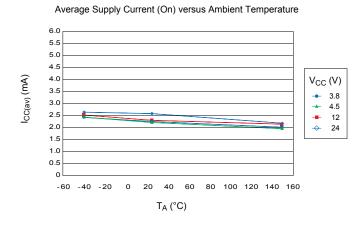
| Characteristic             | Symbol           | Notes  | Rating | Unit |
|----------------------------|------------------|--|--------|------|
| Package Thermal Resistance | R <sub>θJA</sub> | Package LH, 2-layer PCB with 0.463 in. <sup>2</sup> of copper area each side connected by thermal vias | 110    | °C/W |
|                            |                  | Package LH, 1-layer PCB with copper limited to solder pads   | 228    | °C/W |
|                            |                  | Package UA, 1-layer PCB with copper limited to solder pads   | 165    | °C/W |



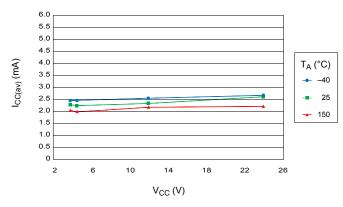


### CHARACTERISTIC PERFORMANCE

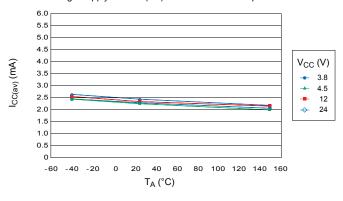
A1225, A1227, and A1229 Electrical Characteristics



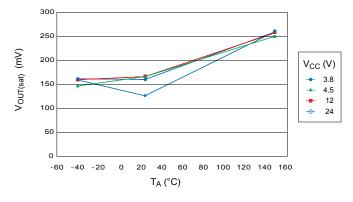
Average Supply Current (On) versus Supply Voltage



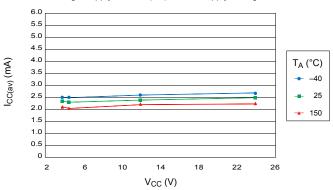
Average Supply Current (Off) versus Ambient Temperature



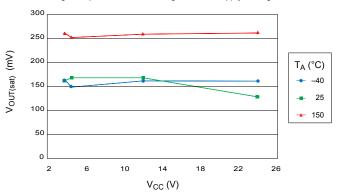
Average Output Saturation Voltage versus Ambient Temperature



Average Supply Current (Off) versus Supply Voltage



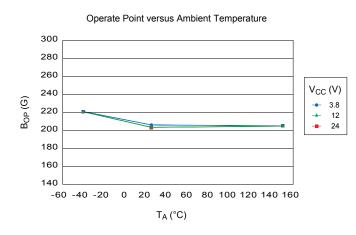
Average Output Saturation Voltage versus Supply Voltage

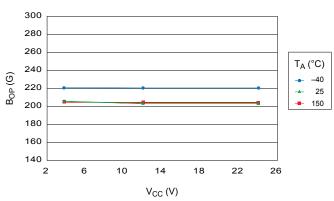




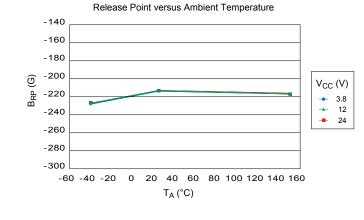
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### A1225 Magnetic Characteristics

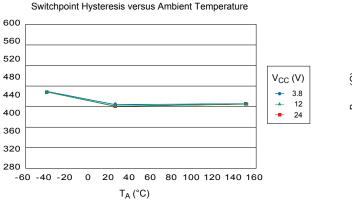




#### Operate Point versus Supply Voltage

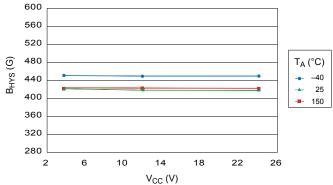


Release Point versus Supply Voltage -140 -160 -180 -200 Ð T<sub>A</sub> (°C) BRP -220 -40 -----25 -240 -150 -260 -280 -300 2 6 10 14 18 22  $V_{CC}(V)$ 



B<sub>HYS</sub> (G)

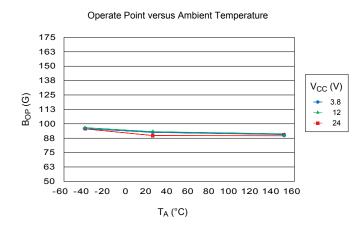
Switchpoint Hysteresis versus Supply Voltage

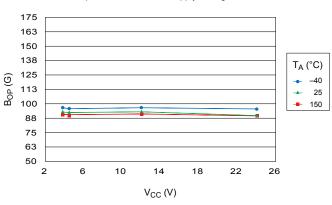




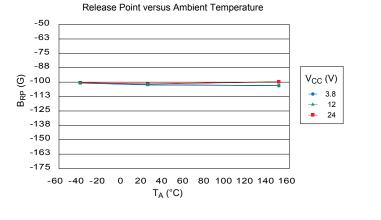
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### A1227 Magnetic Characteristics

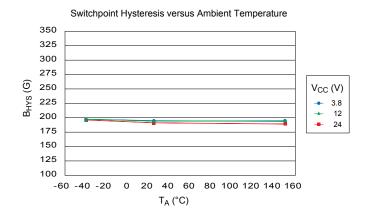




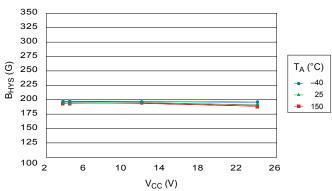
#### Operate Point versus Supply Voltage



Release Point versus Supply Voltage -50 -63 -75 -88 ල් -100 T<sub>A</sub> (°C) ВRР -113 -40 -----125 -25 -150 -138 -150 -163 -175 2 6 10 14 18 22 26  $V_{CC}(V)$ 



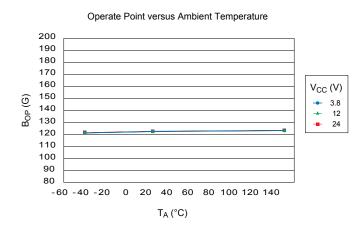
Switchpoint Hysteresis versus Supply Voltage





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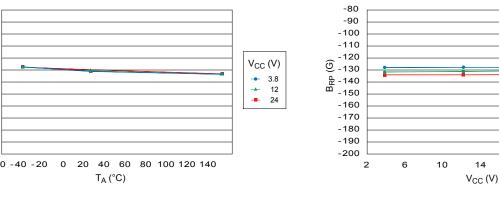
### A1229 Magnetic Characteristics

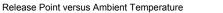


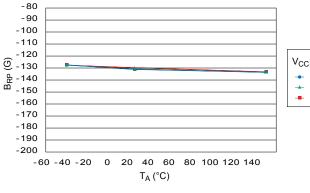
200 190 180 170 160 T<sub>A</sub> (°C) 150 ΰ 140 Вор -25 130 • 150 120 110 100 90 80 6 10 26 2 14 18 22  $V_{CC}(V)$ 

Release Point versus Supply Voltage

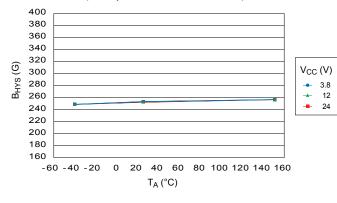
#### Operate Point versus Supply Voltage







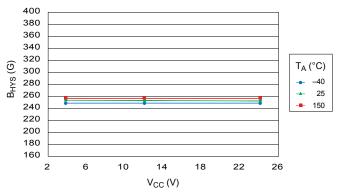




Switchpoint Hysteresis versus Supply Voltage

18

22





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T<sub>A</sub> (°C)

**—** —40

-25

. 150

26

## FUNCTIONAL DESCRIPTION AND APPLICATION INFORMATION

### SWITCHING BEHAVIOR

The output of the A1225, A1227, and A1229 devices switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold,  $B_{OP}$  (see figure 1). After turn-on, the output is capable of sinking 25 mA and the output voltage is  $V_{OUT(sat)}$ . Notice that the device latches; that is, a south pole of sufficient strength towards the branded surface of the device turns the device on, and the device remains on with removal of the south pole.

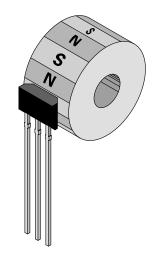
When the magnetic field is reduced below the release point,  $B_{RP}$ , the device output goes high (turns off). The difference between the magnetic operate point and release point is the hysteresis,  $B_{HYS}$ , of the device. This built-in hysteresis allows clean switching of the output, even in the presence of external mechanical vibration and electrical noise.

When the device is powered-on in the hysteresis range, less than  $B_{OP}$  and higher than  $B_{RP}$ , the device output goes high. The correct output state is attained after the first excursion beyond  $B_{OP}$  or  $B_{RP}$ .

### **APPLICATION INFORMATION**

The simplest form of magnet that will operate these devices is a ring magnet, as shown in figure 2. Other methods of operation are possible.

In three-wire applications the device output is connected through a pull-up resistor to the supply pin or separate battery voltage (figure 3). Switching of the output signal indicates sufficient change of the magnetic field.



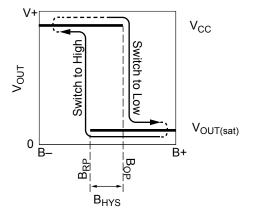


Figure 2. Typical magnetic target configuration using a ring magnet

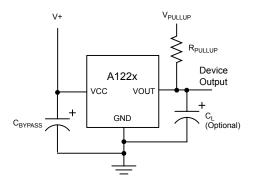


Figure 1. Output switching characteristics

Figure 3. Typical 3-wire application circuit



### **CHOPPER STABILIZATION TECHNIQUE**

When using Hall-effect technology, a limiting factor for switchpoint accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionally small relative to the offset that can be produced at the output of the Hall sensor IC. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges. Chopper stabilization is a unique approach used to minimize Hall offset on the chip. Allegro employs a technique to remove key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulation-demodulation process. The undesired offset signal is separated from the magnetic fieldinduced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic field-induced signal to recover its original spectrum at base band, while the DC offset becomes

a high-frequency signal. The magnetic-sourced signal then can pass through a low-pass filter, while the modulated DC offset is suppressed. In addition to the removal of the thermal and stress related offset, this novel technique also reduces the amount of thermal noise in the Hall sensor IC while completely removing the modulated residue resulting from the chopper operation. The chopper stabilization technique uses a high-frequency sampling clock. For the demodulation process, a sample-and-hold technique is used. This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signalprocessing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

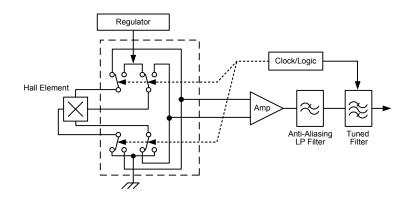
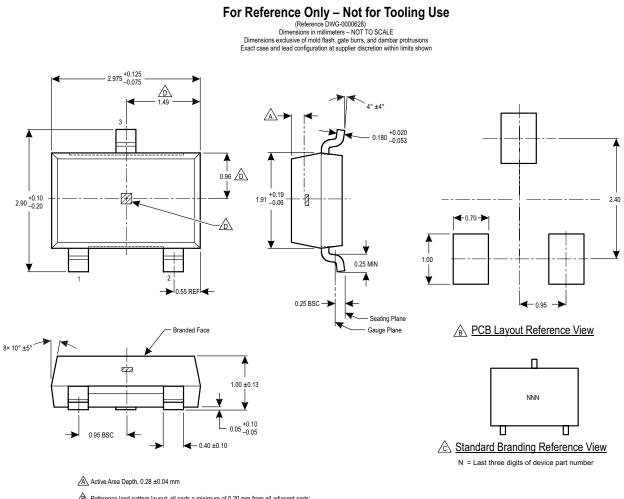


Figure 4. Chopper stabilization technique



## Package LH 3-Pin SOT23W



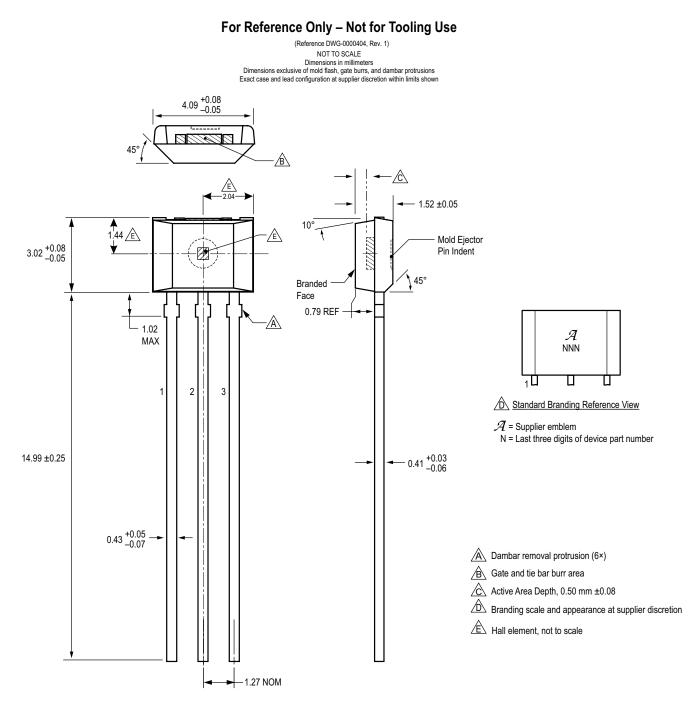
B Reference land pattern layout; all pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances

A Branding scale and appearance at supplier discretion

All elements, not to scale

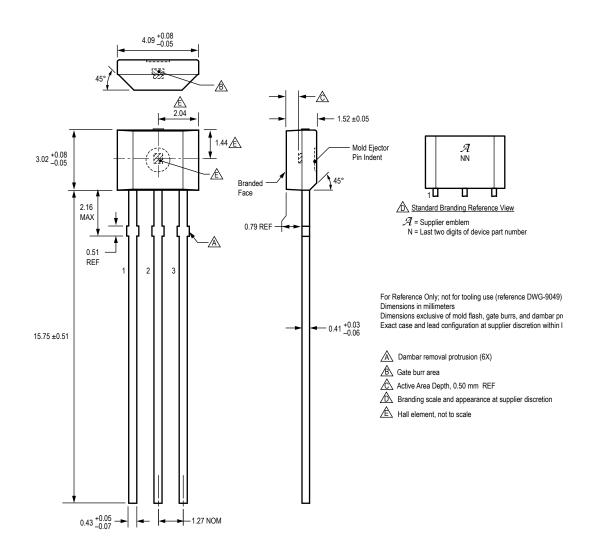


## Package UA 3-Pin SIP, Matrix Style





## Package UA 3-Pin SIP, Chopper Style





**Revision History** 

| Revision | Revision Date      | Description of Revision   |
|----------|--------------------|---|
| 2        | May 8, 2013        | Update product offerings, editorial correction to I <sub>Z(sup)</sub> |
| 3        | March 7, 2016      | Updated product offerings   |
| 4        | October 31, 2016   | Chopper-style UA package designated as not for new design             |
| 5        | June 19, 2018      | Corrected matrix-style UA package drawing                             |
| 6        | September 10, 2018 | Updated product status to not for new design                          |
| 7        | September 30, 2019 | Updated LH package drawing (p. 11), and other minor editorial updates |

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